4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

General Description

The MAX17634x is a high-efficiency, high-voltage, synchronous step-down DC-DC converter with integrated MOSFETs operating over an input-voltage range of 4.5V to 36V. It can deliver up to 4.25A current. The MAX17634 is available in three variants: MAX17634A, MAX17634B, and MAX17634C. The MAX17634A and MAX17634B are fixed 3.3V and fixed 5V output voltage parts, respectively. The MAX17634C is an adjustable output voltage (from $0.9V$ up to 90% of V_{IN}) part. Built-in compensation across the output voltage range eliminates the need for external components.

The MAX17634x features peak-current-mode control architecture. The device can be operated in forced pulsewidth modulation (PWM), pulse-frequency modulation (PFM), or discontinuous-conduction mode (DCM) to enable high efficiency under full-load and lightload conditions. The MAX17634x offers a low minimum on time that allows high switching frequencies and a smaller solution size.

The feedback voltage regulation accuracy over -40°C to +125°C for the MAX17634x is ±1.3%.The device is available in a compact 20-pin (4mm x 4mm) TQFN package. Simulation models are available.

Applications

- Industrial Control Power Supplies
- General-Purpose Point-of-Load
- **Distributed Supply Regulation**
- Base Station Power Supplies
- **Wall Transformer Regulation**
- High-Voltage, Single-Board Systems

Typical Application Circuit

Benefits and Features

- Reduces External Components and Total Cost
	- No Schottky–Synchronous Operation
	- Internal Compensation Components
	- All-Ceramic Capacitors, Compact Layout
- Reduces Number of DC-DC Regulators to Stock
	- Wide 4.5V to 36V Input
	- Adjustable Output Range from 0.9V up to 90% of V_{1N}
	- 400kHz to 2.2MHz Adjustable Frequency with External Synchronization
	- Available in a 20-Pin, 4mm x 4mm TQFN Package
- Reduces Power Dissipation
	- Peak Efficiency of 94%
	- PFM and DCM Modes Enable Enhanced Light-Load Efficiency
	- Auxiliary Bootstrap Supply (EXTVCC) for Improved **Efficiency**
	- 2.8μA Shutdown Current
- Operates Reliably in Adverse Industrial Environments
	- Hiccup-Mode Overload Protection
	- Adjustable and Monotonic Startup with Prebiased Output Voltage
	- Built-in Output-Voltage Monitoring with RESET
	- Programmable EN/UVLO Threshold
	- Overtemperature Protection
	- High Industrial -40°C to +125°C Ambient Operating Temperature Range/-40°C to +150°C Junction Temperature Range

[Ordering Information](#page-20-0) appears at end of data sheet.

19-100572; Rev 0; 6/19

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Absolute Maximum Ratings

Note 1: Junction temperature greater than +125°C degrades operating lifetimes

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

TQFN

For the latest package outline information and land patterns (footprints), go to **www.maximintegrated.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Note 2: Package thermal resistances were obtained using the MAX17634 evaluation kit with no airflow

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Electrical Characteristics

 $(V_{IN} = V_{EN/UVLO} = 24V$, $R_{RT} =$ unconnected (f_{SW} = 500 kHz), $C_{INTVCC} = 2.2uF$, $V_{SGND} = V_{PGND} = V_{MODESYNC} = V_{EXTVCC} = 0V$; $\rm V_{FB}$ = 3.67V (MAX17634A), $\rm V_{FB}$ = 5.5V (MAX17634B), $\rm V_{FB}$ = 1V (MAX17634C), LX = SS = RESET = OPEN, $\rm V_{BST}$ to $\rm V_{LX}$ = 5V, ${\sf T_A}$ = -40°C to 125°C, unless otherwise noted. Typical values are at ${\sf T_A}$ = +25°C. All voltages are referenced to SGND, unless otherwise noted.) (Note 3)

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Electrical Characteristics (continued)

 $(V_{IN} = V_{EN/UVLO} = 24V$, $R_{RT} =$ unconnected (f_{SW} = 500 kHz), $C_{INTVCC} = 2.2uF$, $V_{SGND} = V_{PGND} = V_{MODESYNC} = V_{EXTVCC} = 0V$; V_{FB} = 3.67V (MAX17634A), V_{FB} = 5.5V (MAX17634B), V_{FB} = 1V (MAX17634C), LX = SS = RESET = OPEN, V_{BST} to V_{LX} = 5V, T_A = -40°C to 125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.) (Note 3)

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Electrical Characteristics (continued)

 $(V_{IN} = V_{EN/UVLO} = 24V$, $R_{RT} =$ unconnected (f_{SW} = 500 kHz), $C_{INTVCC} = 2.2uF$, $V_{SGND} = V_{PGND} = V_{MODESYNC} = V_{EXTVCC} = 0V$; V_{FB} = 3.67V (MAX17634A), V_{FB} = 5.5V (MAX17634B), V_{FB} = 1V (MAX17634C), LX = SS = RESET = OPEN, V_{BST} to V_{LX} = 5V, T_A = -40°C to 125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.) (Note 3)

Note 3: Electrical specifications are production tested at $T_A = +25^{\circ}$ C. Specifications over the entire operating temperature range are guaranteed by design and characterization.

Note 4: See the *[Overcurrent Protection/Hiccup Mode](#page-15-0)* Section for more details

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Operating Characteristics

((V_{EN/UVLO} = V_{IN} = 24V, V_{SGND} = V_{PGND} = 0V, C_{INTVCC} = 2.2µF, C_{BST} = 0.1µF, C_{SS} = 5600pF, T_A = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.))

EFFICIENCY (%)

EFFICIENCY (%)

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Operating Characteristics (continued)

((V_{EN/UVLO} = V_{IN} = 24V, V_{SGND} = V_{PGND} = 0V, C_{INTVCC} = 2.2µF, C_{BST} = 0.1µF, C_{SS} = 5600pF, T_A = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.))

CONDITIONS: 3.3V OUTPUT, PWM MODE, 0.776Ω LOAD

SOFT-START WITH PREBIAS OF VOLTAGE 1.65V FIGURE 3 AND FIGURE 5 CIRCUITS

CONDITIONS: 3.3V OUTPUT, PWM MODE, 66Ω LOAD

CONDITIONS: 3.3V OUTPUT, DCM MODE, 50mA LOAD

www.maximintegrated.com Maxim Integrated | 7

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Operating Characteristics (continued)

((V_{EN/UVLO} = V_{IN} = 24V, V_{SGND} = V_{PGND} = 0V, C_{INTVCC} = 2.2µF, C_{BST} = 0.1µF, C_{SS} = 5600pF, T_A = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.))

> **STEADY-STATE PERFORMANCE FIGURE 4 AND FIGURE 6 CIRCUITS**

> > 20V/div

mV/div

5A/div

100mV/div

toc26

toc20

CONDITIONS: 3.3V OUTPUT, PFM MODE, 50mA LOAD

50mV/div toc23 100µs/div **LOAD TRANSIENT BETWEEN 0A AND 2A FIGURE 3 AND FIGURE 5 CIRCUITS** IOUT 1A/div CONDITIONS: 3.3V OUTPUT, PWM MODE VOUT (AC

> **LOAD TRANSIENT BETWEEN 0.05A AND 2A FIGURE 3 AND FIGURE 5 CIRCUITS**

> > 400µs/div

CONDITIONS: 3.3V OUTPUT, PFM MODE

IOUT 1A/div

CONDITIONS: 3.3V OUTPUT, PWM/PFM/DCM MODE

0mV/div toc25 **LOAD TRANSIENT BETWEEN 0.05A AND 2A FIGURE 3 AND FIGURE 5 CIRCUITS** VOUT (AC

100µs/div CONDITIONS: 3.3V OUTPUT, DCM MODE

IOUT 1A/div

VOUT (AC)

WW

VLX

VOUT (AC

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Operating Characteristics (continued)

((V_{EN/UVLO} = V_{IN} = 24V, V_{SGND} = V_{PGND} = 0V, C_{INTVCC} = 2.2µF, C_{BST} = 0.1µF, C_{SS} = 5600pF, T_A = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.))

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Operating Characteristics (continued)

((V_{EN/UVLO} = V_{IN} = 24V, V_{SGND} = V_{PGND} = 0V, C_{INTVCC} = 2.2µF, C_{BST} = 0.1µF, C_{SS} = 5600pF, T_A = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to SGND, unless otherwise noted.))

CONDITIONS: ADJUSTABLE 3.3V OUTPUT, 4.25A LOAD, PWM MODE

CONDITIONS: MEASURED ON THE MAX17634CEVKIT WITH L2 = 22μH
C12 = C13 = 2.2μF/50V/X7R/1206, C14 = C19 = 4.7μF/50V/X7R/1210

CONDITIONS: ADJUSTABLE 5V OUTPUT, 4.25A LOAD, PWM MODE

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Pin Configuration

Pin Description

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Pin Description (continued)

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Functional Diagram

Detailed Description

The MAX17634x is a high-efficiency, high-voltage, synchronous step-down DC-DC converter with integrated MOSFETs operating over an input voltage range of 4.5V to 36V. It can deliver up to 4.25A current. The MAX17634A and MAX17634B are the fixed 3.3V and fixed 5V output parts, respectively. The MAX17634C is an adjustable output voltage (from 0.9V upto 90% of V_{IN}) part. Built-in compensation across the output voltage range eliminates the need for external compensation components. The feedback (FB) voltage regulation accuracy over -40°C to +125°C is ±1.3% for MAX17634x.

The device features a peak-current-mode control architecture. An internal transconductance error amplifier produces an integrated error voltage at an internal node, which sets the duty cycle using a PWM comparator, a high-side current-sense amplifier, and a slope-compensation generator. At each rising edge of the clock, the highside MOSFET turns on and remains on until either the appropriate or maximum duty cycle is reached, or the peak current limit is detected. During the high-side MOSFET's on-time, the inductor current ramps up. During the second half of the switching cycle, the high-side MOSFET turns off and the low-side MOSFET turns on. The inductor releases the stored energy as its current ramps down and provides current to the output.

The device features a MODE/SYNC pin that can be used to operate the device in PWM, PFM, or DCM control schemes. The device also features adjustableinput undervoltage lockout, adjustable soft-start, open drain RESET, and external frequency synchronization features. The MAX17634x offers a low minimum on time that enables to design converter at higher switching frequencies and a small solution size.

Mode Selection and External Clock Synchronization (MODE/SYNC):

The MAX17634x supports the PWM, PFM, and DCM modes of operation. The device enters the required mode of operation based on the setting of the MODE/ SYNC pin as detected within 1.5ms after INTVCC and EN/UVLO voltages exceed their respective UVLO rising thresholds (VINTVCC-UVR, VENR). If the MODE/SYNC pin is open, the device operates in PFM mode at light loads. If the state of the MODE/SYNC pin is low $(< V_{M-PWM})$, the device operates in constant-frequency PWM mode at all loads. If the state of the MODE/SYNC pin is high $(>V_{M-DCM})$, the device operates in DCM mode at light loads.

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

During external clock synchronization the device operates in PWM mode, irrespective of whether PWM or DCM mode is set. When 16 external clock rising edges are detected on the MODE/SYNC pin, the internal oscillator frequency set by RT pin (f_{SW}) changes to external clock frequency. The device remains in PWM mode until EN/UVLO or input power is cycled. The external clock frequency must be between 1.1 x f_{SW} and 1.4 x f_{SW} . The minimum external clock pulse width should be greater than 50ns. The off-time duration of the external clock should be at least 160ns.

If PFM mode of operation is set, the device ignores the external clock pulses and remains in PFM mode. Thus, external clock synchronization is not supported in PFM mode.

See the MODE/SYNC section of the *[Electrical](#page-2-0) [Characteristics](#page-2-0)* table for details.

PWM Mode Operation

In PWM mode, the inductor current is allowed to go negative. PWM operation provides constant frequency operation irrespective of loading, and is useful in applications sensitive to switching frequency. However, the PWM mode of operation gives lower efficiency at light loads compared to PFM and DCM modes of operation.

PFM Mode Operation

PFM mode of operation disables negative inductor current and additionally skips pulses at light loads for high efficiency. In PFM mode, the inductor current is forced to a fixed peak of I_{PFM} (1.6A, typ) every clock cycle until the output rises to 102.3% of the set nominal output voltage. Once the output reaches 102.3% of the set nominal output voltage, both the high-side and low-side FETs are turned off and the device enters hibernate operation until the load discharges the output to 101.1% of the set nominal output voltage. Most of the internal blocks are turned off in hibernate operation to save quiescent current. After the output falls below 101.1% of the set nominal output voltage, the device comes out of hibernate operation, turns on all internal blocks, and again commences the process of delivering pulses of energy to the output until it reaches 102.3% of the set nominal output voltage. The advantage of the PFM mode is higher efficiency at light loads because of lower quiescent current drawn from the supply. The disadvantage is that the output-voltage ripple is higher compared to PWM or DCM modes of operation and switching frequency is not constant at light loads.

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

DCM Mode Operation

DCM mode of operation features constant frequency operation down to lighter loads than PFM mode, by disabling negative inductor current at light loads. DCM operation offers efficiency performance that lies between PWM and PFM modes. The output voltage ripple in DCM mode is comparable to PWM mode and relatively lower compared to PFM mode.

Linear Regulator (INTVCC and EXTVCC)

The MAX17634x has an internal LDO (low dropout) regulator that powers INTVCC from IN. This LDO is enabled during power-up or when EN/UVLO is above 0.75V (typ). An internal switch connects the EXTVCC to INTVCC. The switch is open during power up. If INTVCC is above its UVLO threshold and, if EXTVCC is greater than 4.7V (typ), the internal LDO is disabled and INTVCC is powered from EXTVCC. Powering INTVCC from EXTVCC increases efficiency at higher input voltages. Typical INTVCC output voltage is 5V. Bypass INTVCC to SGND with a 2.2µF low-ESR ceramic capacitor. INTVCC powers the internal blocks and the low-side MOSFET driver and recharges the external bootstrap capacitor.

The MAX17634x employs an undervoltage lockout circuit that forces the buck converter off when INTVCC falls below $V_{\text{INTVCC-LIVE}}$ (3.8, typ). The buck converter can be immediately enabled again when INTVCC $>$ V_{INTVCC-UVR} (4.2, typ). The 400mV UVLO hysteresis prevents chattering on power-up/power-down.

In applications where the buck converter output is connected to EXTVCC pin, if the output is shorted to ground then the transfer from EXTVCC to internal LDO happens seamlessly without any impact on the normal functionality. Connect the EXTVCC pin to SGND, when not in use.

Setting the Switching Frequency (RT)

The switching frequency of the device can be programmed from 400kHz to 2.2MHz by using a resistor connected from the RT pin to SGND. The switching frequency (f_{SW}) is related to the resistor (R_{RT}) connected at the RT pin by the following equation:

$$
R_{RT} \cong \frac{21000}{f_{SW}} - 1.7
$$

Where R_{RT} is in kΩ and f_{SW} is in kHz. Leaving the RT pin open will force the device to operate at default switching frequency of 500kHz. See [Table 1](#page-14-1) for RRT resistor values for a few common switching frequencies.

Operating Input Voltage Range

The minimum and maximum operating input voltages for a given output voltage setting should be calculated as follows:

$$
V_{IN(MIN)} = \frac{V_{OUT} + (I_{OUT(MAX)} \times (R_{DCR(MAX)} + R_{DS-ONL(MAX)}))}{1 - (f_{SW(MAX)} \times t_{OFF-MIN(MAX)})}
$$

$$
+ (I_{OUT(MAX)} \times (R_{DS-ONH(MAX)} - R_{DS-ONL(MAX)}))
$$

$$
V_{IN(MAX)} = \frac{V_{OUT}}{f_{SW(MAX)} \times t_{ON-MIN(MAX)}}
$$

Where

 V_{OUT} = Steady-state output voltage,

 $I_{\text{OUT}(MAX)} =$ Maximum load current,

 R_{DCR} = Worst-case DC resistance of the inductor,

 $f_{SW(MAX)} =$ Maximum switching frequency,

 t _{OFF-MIN(MAX)} = Worst-case minimum switch off-time (160ns),

tON-MIN(MAX) =Worst-case minimum switch on-time (80ns),

RDS-ONL(MAX) and RDS-ONH(MAX) = Worst-case onstate resistances of low-side and high-side internal MOSFETs, respectively.

Table 1. Switching Frequency vs. RRT Resistor

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Overcurrent Protection/Hiccup Mode

The device is provided with a robust overcurrent protection (OCP) scheme that protects the device under overload and output short-circuit conditions. A cycle-by-cycle peak current limit turns off the high-side MOSFET whenever the high-side switch current exceeds an internal limit of $IPFAK-IMIT$ (6.7A, typ). A runaway current limit on the high-side switch current at IRUNAWAY-LIMIT (7.8A, typ) protects the device under high input voltage, output short-circuit conditions when there is insufficient output voltage available to restore the inductor current that was built up during the on period of the step-down converter. One occurrence of the runaway current limit triggers a hiccup mode. In addition, if feedback voltage drops to $V_{FB-HICF}$ due to a fault condition, hiccup mode is triggered 1024 clock cycles after soft-start time is completed. In hiccup mode, the converter is protected by suspending switching for a hiccup timeout period of 32,768 clock cycles of half the switching frequency. Once the hiccup timeout period expires, soft-start is attempted again. Note that when soft-start is attempted under overload condition, if feedback voltage does not exceed VFB-HICF, the device continues to switch at half the programmed switching frequency for the time duration of the programmed soft-start time and 1024 clock cycles. Hiccup mode of operation ensures low power dissipation under output short-circuit conditions.

RESET Output

The device includes a RESET comparator to monitor the status of output voltage. The open-drain RESET output requires an external pullup resistor. RESET goes high (high impedance) with a delay of 1024 switching cycles after the regulator output increases above 95% (V_{FB-OKR}) of V_{FB-REG} . RESET goes low when the regulator output voltage drops to below 92% (V_{FB-OKF}) of VFB-REG. RESET also goes low during thermal shutdown or when EN/UVLO pin goes below VENF.

Prebiased Output

When the device starts into a prebiased output, both the high-side and the low-side switches are turned off so that the converter does not sink current from the output. Highside and low-side switches do not start switching until the PWM comparator commands the first PWM pulse, at which point switching commences. The output voltage is then smoothly ramped up to the target value in alignment with the internal reference.

Thermal-Shutdown Protection

Thermal-shutdown protection limits junction temperature in the device. When the junction temperature of the device exceeds +165°C, an on-chip thermal sensor shuts down the device, allowing the device to cool. The device turns on with soft-start after the junction temperature reduces by 10°C. Carefully evaluate the total power dissipation (see the *[Power Dissipation](#page-17-1)* section) to avoid unwanted triggering of the thermal shutdown in normal operation.

Applications Information

Input Capacitor Selection

The input filter capacitor reduces peak currents drawn from the power source and reduces noise and voltage ripple on the input caused by the circuit's switching. The input capacitor RMS current requirement (IRMS) is defined by the following equation:

$$
I_{RMS} = I_{OUT(MAX)} \times \frac{\sqrt{V_{OUT} \times (V_{IN} - V_{OUT})}}{V_{IN}}
$$

where, $I_{\text{OUT}(MAX)}$ is the maximum load current. I_{RMS} has a maximum value when the input voltage equals twice the output voltage (V_{IN} = 2 x V_{OUT}), so $I_{RMS(MAX)}$ = $I_{OUT/MAX}/2$. Choose an input capacitor that exhibits less than +10°C temperature rise at the RMS input current for optimal long-term reliability. Use low-ESR ceramic capacitors with high-ripple-current capability at the input. X7R capacitors are recommended in industrial applications for their temperature stability. Calculate the input capacitance using the following equation:

$$
C_{IN} = \frac{I_{OUT(MAX)} \times D \times (1 - D)}{n \times f_{SW} \times \Delta V_{IN}}
$$

where,

 $D = V_{\text{OUT}}/V_{\text{IN}}$ is the duty ratio of the converter,

 f_{SW} = Switching frequency,

 ΔV_{IN} = Allowable input voltage ripple,

η = Efficiency.

In applications where the source is located distant from the device input, an appropriate electrolytic capacitor should be added in parallel to the ceramic capacitor to provide necessary damping for potential oscillations caused by the inductance of the longer input power path and input ceramic capacitor.

Inductor Selection

Three key inductor parameters must be specified for operation with the device: inductance value (L), inductor saturation current (I_{SAT}) and DC resistance (R_{DCR}). The switching frequency and output voltage determine the inductor value as follows:

$$
L = \frac{0.7 \times V_{OUT}}{f_{SW}}
$$

where V_{OUT} and f_{SW} are nominal values and f_{SW} is in Hz. Select an inductor whose value is nearest to the value calculated by the previous formula. Select a low-loss inductor closest to the calculated value with acceptable dimensions and having the lowest possible DC resistance. The saturation current rating (I_{SAT}) of the inductor must be high enough to ensure that saturation can occur only above the peak current-limit value of I PFAK-LIMIT $(6.7A, typ)$.

Output Capacitor Selection

X7R ceramic output capacitors are preferred due to their stability over temperature in industrial applications. Output capacitor is calculated and sized to support a 50% of maximum output current as the dynamic step load, and to contain the output voltage deviation to within ±3% of the output voltage. The minimum required output capacitance can be calculated as follows:

$$
C_{OUT} = \frac{1}{2} \times \frac{1_{STEP} \times t_{RESPONSE}}{\Delta V_{OUT}}
$$

$$
t_{RESPONSE} \approx \frac{0.35}{t_C}
$$

where,

 $I_{STEP} =$ Load current step,

 $t_{RFSPONSF}$ = Response time of the controller,

 ΔV_{OUT} = Allowable output-voltage deviation,

 f_C = Target closed-loop crossover frequency,

 f_{SW} = Switching frequency.

Select f_C to be 1/10th of f_{SW} for the switching frequencies less than or equal to 800 kHz. If the switching frequency is more than 800 kHz, select f_C to be 80kHz. Actual derating of ceramic capacitors with DC bias voltage must be considered while selecting the output capacitor. Derating curves are available from all major ceramic capacitor manufacturers.

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Soft-Start Capacitor Selection

The device implements adjustable soft-start operation to reduce inrush current. A capacitor connected from the SS pin to SGND programs the soft-start time. The selected output capacitance (C_{SEL}) and the output voltage (V_{OUT}) determine the minimum required soft-start capacitor as follows:

$$
C_{SS} \ge 28 \times 10^{-6} \times C_{SEL} \times V_{OUT}
$$

The soft-start time (t_{SS}) is related to the capacitor connected at SS (C_{SS}) by the following equation:

$$
t_{SS} = \frac{C_{SS}}{5.55 \times 10^{-6}}
$$

For example, to program a 1ms soft-start time, a 5.6nF capacitor should be connected from the SS pin to SGND. Note that, during startup, the device operates at half the programmed switching frequency until the output voltage reaches 64.4% of set output nominal voltage.

Setting the Input Undervoltage-Lockout Level

The device offers an adjustable input undervoltagelockout level. Set the voltage at which the device turns on with a resistive voltage-divider connected from INto SGND (see [Figure 1](#page-16-0)). Connect the center node of the divider to EN/UVLO. Choose R_{TOP} to be 3.3MΩ and then calculate R_{ROTTOM} as follows:

$$
R_{\text{BOTTOM}} = \frac{R_{\text{TOP}} \times 1.215}{(V_{\text{INU}} - 1.215)}
$$

where V_{INU} is the voltage at which the device is required to turn on. Ensure that V_{INU} is higher than 0.8 x V_{OUT} to avoid hiccup during slow power-up (slower than softstart)/ power-down. If the EN/UVLO pin is driven from an external signal source, a series resistance of minimum 1kΩ is recommended to be placed between the output pin of signal source and the EN/UVLO pin, to reduce voltage ringing on the line.

Figure 1. Setting the Input Undervoltage Lockout

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Adjusting Output Voltage

Set the output voltage with a resistive voltage-divider connected from the output-voltage node (V_{OUT}) to SGND (see [Figure 2](#page-17-2)). Connect the center node of the divider to the FB pin for MAX17634C. Connect the output voltage node (V_{OUT}) to the FB pin for MAX17634A and MAX17634B. Use the following procedure to choose the resistive voltage-divider values:

Calculate resistor R_{U} from the output to the FB pin as follows:

$$
R_U = \frac{320}{f_C \times C_{OUT_SEL}}
$$

where,

 R_{U} is in kΩ,

 f_C = Crossover frequency is in Hz,

 C_{OUT} SFI = Actual capacitance of selected output capacitor at DC-bias voltage in F.

Calculate resistor R_B connected from the FB pin to SGND as follows:

$$
R_B = \frac{R_U \times 0.9}{(V_{OUT} - 0.9)}
$$

 R _B is in kΩ.

Select an appropriate f_C and C_{OUT}, so that the parallel combination of R_B and R_U is less than 50k Ω .

Power Dissipation

At a particular operating condition, the power losses that lead to temperature rise of the part are estimated as follows:

$$
P_{LOSS} = (P_{OUT} \times (\frac{1}{n} - 1)) - (I_{OUT}^2 \times R_{DCR})
$$

$$
P_{OUT} = V_{OUT} \times I_{OUT}
$$

where,

 P_{OUT} = Output power,

η = Efficiency of the converter.

R_{DCR} = DC resistance of the inductor (see the *[Typical](#page-5-0) [Operating Characteristics](#page-5-0)* for more information on efficiency at typical operating conditions).

Figure 2. Setting the Output Voltage

For a typical multilayer board, the thermal performance metrics for the package are given below:

$$
\theta_{JA} = 26^{\circ}C/W
$$

$$
\theta_{JC} = 2^{\circ}C/W
$$

The junction temperature of the device can be estimated at any given maximum ambient temperature $(T_{A(MAX)})$ from the following equation:

$$
T_{J(MAX)} = T_{A(MAX)} + (\theta_{JA} \times P_{LOSS})
$$

If the application has a thermal-management system that ensures that the exposed pad of the device is maintained at a given temperature $(T_{EP(MAX)})$ by using proper heat sinks, then the junction temperature of the device can be estimated at any given maximum ambient temperature as:

$$
T_{J(MAX)} = T_{EP(MAX)} + (\theta_{JC} \times P_{LOSS})
$$

Note: Junction temperatures greater than +125°C degrades operating lifetimes.

PCB Layout Guidelines

All connections carrying pulsed currents must be very short and as wide as possible. The inductance of these connections must be kept to an absolute minimum due to the high di/dt of the currents. Since inductance of a current carrying loop is proportional to the area enclosed by the loop, if the loop area is made very small, inductance is reduced. Additionally, small-current loop areas reduce radiated EMI.

A ceramic input filter capacitor should be placed close to the IN pins of the IC. This eliminates as much trace inductance effects as possible and gives the IC a cleaner voltage supply. A bypass capacitor for the INTVCC pin also should be placed close to the pin to reduce effects of trace impedance.

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

When routing the circuitry around the IC, the analog small signal ground and the power ground for switching currents must be kept separate. They should be connected together at a point where switching activity is at a minimum. This helps keep the analog ground quiet. The ground plane should be kept continuous/unbroken as far as possible. No trace carrying high switching current should be placed directly over any ground plane discontinuity.

PCB layout also affects the thermal performance of the design. A number of thermal throughputs that connect to a large ground plane should be provided under the exposed pad of the part, for efficient heat dissipation.

For a sample layout that ensures first pass success, refer to the MAX17634 evaluation kit layout available at **www.maximintegrated.com**.

Typical Application Circuits

Adjustable 3.3V Output Typical Application Circuit

Figure 3. Adjustable 3.3V Output with 400kHz Switching Frequency

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Application Circuits (continued)

Adjustable 5V Output Typical Application Circuit

Figure 4. Adjustable 5V Output with 400kHz Switching Frequency

Fixed 3.3V Output Typical Application Circuit

Figure 5. Fixed 3.3V Output with 400kHz Switching Frequency

4.5V to 36V, 4.25A, High-Efficiency, Synchronous Step-Down DC-DC Converter

Typical Application Circuits (continued)

Fixed 5V Output Typical Application Circuit

Figure 6. Fixed 5V Output with 400kHz Switching Frequency

Ordering Information

+Denotes a lead(Pb)-free/RoHS compliant package.